

AMENDMENTS

*In the Claims*

~~Please cancel claims 1-8.~~

~~Please amend claim 9 as follows.~~

9. (amended) A microelectronic fabrication comprising:

a substrate;

*AK*  
*sub*  
*B1*

a spirally patterned conductor layer formed over the substrate, wherein the spirally patterned conductor layer terminates in a microelectronic structure formed within the center of the spirally patterned conductor layer, wherein the spirally patterned conductor layer forms a planar spiral inductor, and wherein the microelectronic structure formed within the center of the spirally patterned conductor layer comprises a series of at least four electrically interconnected sub-patterns.